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MPC5744P

MPC5744P Data Sheet

32-bit MCU suitable for ISO26262 ASIL-D chassis and safety applications

Features

- The MPC5744P microcontroller is based on the Power Architecture® developed by NXP. It targets chassis and safety applications and other applications requiring a high Automotive Safety Integrity Level (ASIL). The MPC5744P is a SafeAssure solution.
- This document provides electrical specifications, pin assignments, and package diagram information for the MPC5744P series of microcontroller units (MCUs). For functional characteristics and the programming model, see the MPC5744P Reference Manual.
- Junction temperature: The upper limit is 150°C or 165°C depending on the device marking.

Table of Contents

1	Introduction.....	3	3.12	Main oscillator electrical characteristics.....	69
1.1	Features.....	3	3.13	PLLDIG electrical characteristics.....	72
1.2	Block Diagram.....	5	3.14	16 MHz Internal RC Oscillator (IRCOSC) electrical specifications.....	73
2	Pinouts.....	6	3.15	ADC electrical characteristics.....	74
2.1	Package pinouts and ballmap.....	6	3.16	Flash memory specifications.....	77
2.2	Pin/ball descriptions	8	3.16.1	Maximum junction temperature 150°C.....	77
2.2.1	Pin/ball startup and reset states.....	8	3.16.2	Maximum junction temperature 165°C.....	80
2.2.2	Power supply and reference voltage pins/balls.....	9	3.16.3	Flash memory read wait-state and address-pipeline control settings.....	84
2.2.3	System pins/balls.....	12	3.17	SGEN electrical characteristics.....	85
2.2.4	LVDS pins/balls.....	13	3.18	RESET sequence duration.....	86
2.2.5	Generic pins/balls.....	14	3.19	AC specifications.....	86
2.2.6	Peripheral input muxing.....	43	3.19.1	Reset pad (EXT_POR, RESET) electrical characteristics.....	87
3	Electrical characteristics.....	55	3.19.2	WKUP/NMI timing.....	89
3.1	Introduction.....	55	3.19.3	Debug/JTAG/Nexus/Aurora timing.....	89
3.2	165°C junction temperature option.....	55	3.19.4	External interrupt timing (IRQ pin).....	96
3.3	Absolute maximum ratings.....	55	3.19.5	SPI timing.....	97
3.4	Recommended operating conditions.....	57	3.19.6	LFAST.....	102
3.5	Thermal characteristics.....	58	3.19.7	FlexRay.....	106
3.5.1	General notes for specifications at maximum junction temperature.....	59	3.19.8	Ethernet switching specifications.....	109
3.6	Electromagnetic compatibility (EMC).....	60	4	Obtaining package dimensions.....	111
3.7	Electrostatic discharge (ESD) characteristics.....	62	5	Ordering information.....	112
3.8	Voltage regulator electrical characteristics.....	62	6	Document revision history.....	113
3.9	DC electrical characteristics.....	65			
3.10	Supply current characteristics.....	67			
3.11	Temperature sensor.....	69			

1 Introduction

1.1 Features

The following table summarizes the features of the MPC5744P.

Table 1. MPC5744P feature summary

Feature	Details
CPU	
Power Architecture	2 x e200z4 in delayed lock step
Architecture	Harvard
Execution speed	0 MHz to 200 MHz (+2% FM)
Embedded FPU	Yes
Core MPU	24 regions
Instruction Set PPC	No
Instruction Set VLE	Yes
Instruction cache	8 KB, EDC
Data cache	4 KB, EDC
Data local memory	64 KB, ECC
System MPU	Yes (16 regions)
Buses	
Core bus	AHB, 32-bit address, 64-bit data, e2e ECC
Internal periphery bus	32-bit address, 32-bit data
Crossbar	
Master x slave ports	4 x 5
Memory —see Table 2 for additional details	
Code/data flash memory	2.5 MB , ECC, RWW
Data flash memory	Supported with RWW
SRAM	384 KB , ECC
Overlay access to SRAM from Flash Memory Controller	Yes
Modules	
Interrupt controller	32 interrupt priority levels, 16 SW programmable interrupts
PIT	1 module with 4 channels
System Timer Module (STM)	1 module with 4 channels
Software Watchdog Timer (SWT)	Yes
eDMA	32 channels, in delayed lock step
FlexRay	1 module with 64 message buffer, dual channel
FlexCAN	3 modules with 64 message buffer
LINFlexD (UART and LIN with DMA support)	2 modules

Table continues on the next page...

Table 1. MPC5744P feature summary (continued)

Feature	Details
Clockout	Yes
Fault Control and Collection Unit (FCCU)	Yes
Cross Triggering Unit (CTU)	2 modules
eTimer	3 modules with 6 channels
FlexPWM	2 modules with 4 x (2+1) channels
Analog-to-digital converter (ADC)	4 modules with 12-bit ADC, each with 16 channels (25 external channels including shared channels plus internal channels)
Sine-wave generator (SGEN)	32 point
SPI	4 modules As many as 8 chip selects
CRC Unit	Yes
SENT	2 modules with 2 channels
Interprocessor serial link interface (SIPI)	Yes
Junction temperature sensor	Yes (replicated module)
Digital I/Os	≥ 16
Peripheral register protection	Yes
Ethernet	Yes
Error Injection Module (EIM)	Yes
Supply	
Device Power Supply	3.3 V with external ballast transistor 3.3 V with external 1.25 V low drop-out (LDO) regulator
ADC Analog Reference voltage	3.15 V to 5.5 V
Clocking	
Phase Lock Loop (PLL)	1 x PLL and 1 coupled FMPLL
Internal RC Oscillator	16 MHz
External Crystal Oscillator	8 MHz to 40 MHz
Low power modes	
HALT and STOP	Yes
Debug	
Nexus	Level 3+, MDO and Aurora interface
Package	
LQFP	144 pins, 0.5 mm pitch, 20 mm x 20 mm outline
MAPBGA	257 MAPBGA, 0.8 mm pitch, 14 mm x 14 mm outline
Temperature	
Temperature range (junction)	-40°C to +150°C, option for 165°C
Ambient temperature range (LQFP)	-40°C to +125°C, 135°C option (with 165°C junction option)
Ambient temperature range (BGA)	-40°C to +125°C, 135°C option (with 165°C junction option)

Table 2. Flash memory and SRAM sizes of MPC5744P, MPC5743P, MPC5742P, and MPC5741P

Part number	Flash memory	SRAM
MPC5744P	2.5 MB	384 KB
MPC5743P	2.0 MB	256 KB
MPC5742P	1.5 MB	192 KB
MPC5741P	1.0 MB	128 KB

1.2 Block Diagram

The following figure is a top-level diagram that shows the functional organization of the system.

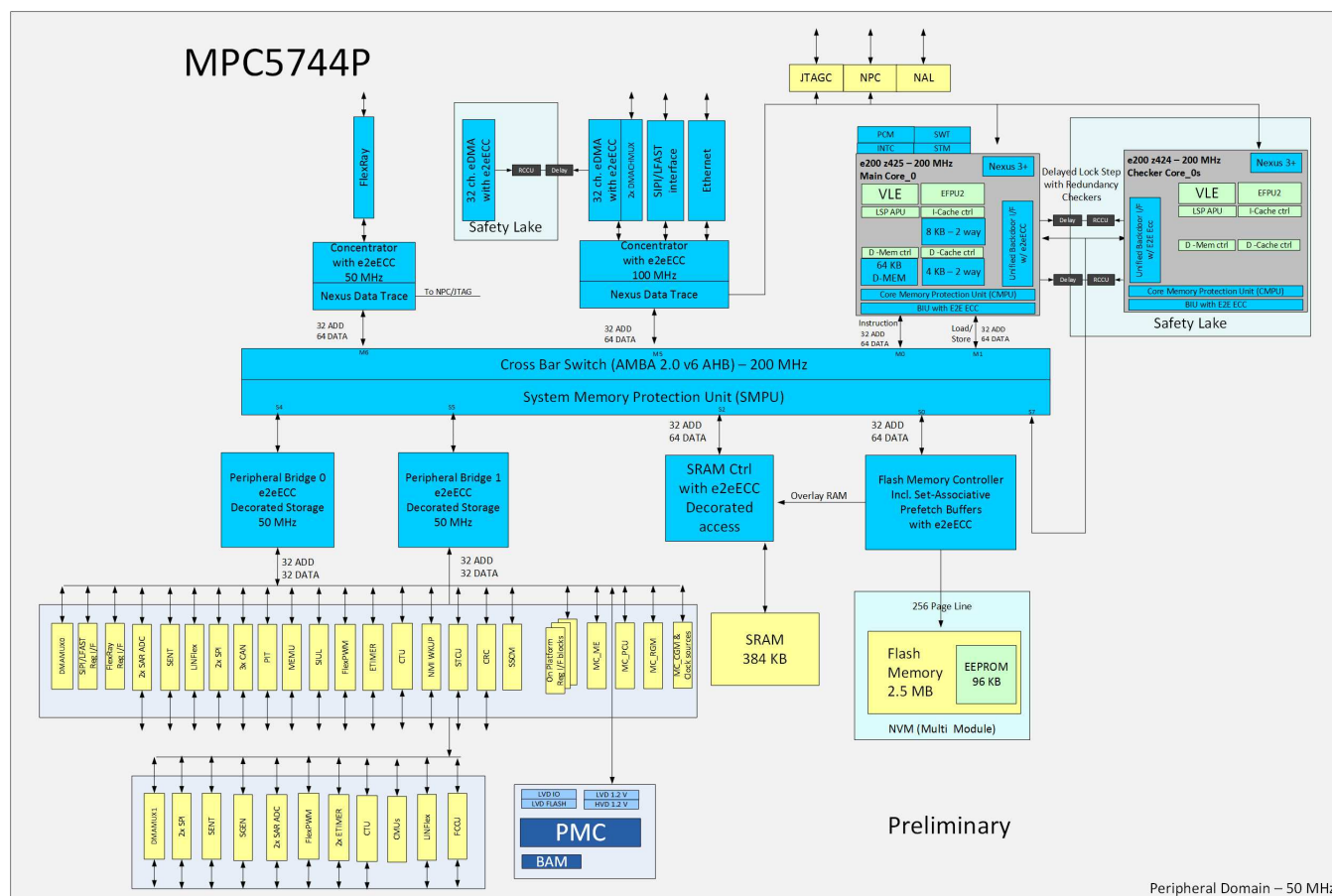


Figure 1. System Block Diagram

2 Pinouts

2.1 Package pinouts and ballmap

The following figures show the LQFP pinout and the BGA ballmap.

	144	143	142	141	140	139	138	137	136	135	134	133	132	131	130	129	128	127	126	125	124	123	122	121	120	119	118	117	116	115	114	113	112	111	110	109		
	A[15]	A[14]	C[6]	FCCU_F1[1]	D[2]	F[3]	B[6]	VSS_LV_COR	A[13]	VDD_LV_COR	A[9]	F[0]	VSS_LV_COR	VDD_LV_COR	EXT_POR_B	D[4]	D[3]	VSS_HV_IO	VDD_HV_IO	D[0]	C[15]	JCOMP	A[12]	E[15]	A[11]	E[14]	A[10]	E[13]	B[3]	F[14]	B[2]	F[15]	F[13]	C[10]	B[1]	B[0]		
1	<p>MPC5744P</p> <p>144 LQFP</p> <p>Freescale Semiconductor</p>																												A[4]	108								
2																													A[6]	VPP/TEST_MODE	107							
3																													D[1]	F[12]	106							
4																													F[4]	D[14]	105							
5																													F[5]	G[3]	104							
6																													VDD_HV_IO	C[14]	103							
7																													VSS_HV_IO	G[2]	102							
8																													F[6]	C[13]	101							
9																													MDO0	G[4]	100							
10																													A[7]	D[12]	99							
11																													C[4]	G[6]	98							
12																													A[8]	VDD_HV_FLTA	97							
13																													C[5]	VSS_LV_COR	96							
14																													A[5]	J[8]	95							
15																													C[7]	VSS_LV_COR	94							
16																													J[9]	VDD_LV_COR	93							
17																													VSS_LV_COR	A[3]	92							
18																													VDD_LV_COR	VDD_HV_IO	91							
19																													F[7]	VSS_HV_IO	90							
20																													F[8]	B[4]	89							
21																													VDD_HV_IO	TCK	88							
22																													VSS_HV_IO	TMS	87							
23																													F[9]	B[5]	86							
24																													F[10]	G[5]	85							
25																													F[11]	A[2]	84							
26																													D[9]	G[7]	83							
27																													VDD_HV_OSC	C[12]	82							
28																													VSS_HV_OSC	G[8]	81							
29																													XTAL	C[11]	80							
30																													EXTAL	G[9]	79							
31																													RESET_B	D[11]	78							
32																													D[8]	G[10]	77							
33																													D[5]	D[10]	76							
34																													D[6]	G[11]	75							
35																													VSS_LV_PLL	A[1]	74							
36	VDD_LV_PLL	A[0]	73																																			
	D[7]																																					
	FCCU_F0[0]																																					
	VDD_LV_COR																																					
	VSS_LV_COR																																					
	C[1]																																					
	E[4]																																					
	B[7]																																					
	E[5]																																					
	C[2]																																					
	E[6]																																					
	B[8]																																					
	E[7]																																					
	E[2]																																					
	VDD_HV_ADRE0																																					
	VSS_HV_ADRE0																																					
	B[9]																																					
	B[10]																																					
	B[11]																																					
	B[12]																																					
	VDD_HV_ADRE1																																					
	VSS_HV_ADRE1																																					
	VDD_HV_ADV																																					
	VSS_HV_ADV																																					
	B[13]																																					
	E[9]																																					
	B[15]																																					
	E[10]																																					
	B[14]																																					
	E[11]																																					
	C[0]																																					
	E[12]																																					
	E[0]																																					
	BCTRL																																					
	VDD_LV_COR																																					
	VSS_LV_COR																																					
	VDD_HV_PMDIO																																					

Figure 2. 144LQFP pinout

	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17
A	VSS_HV_IO	VSS_HV_IO	A[14]	A[9]	D[3]	JCOMP	H[12]	C[15]	VDD_HV_IO	I[3]	E[13]	J[1]	F[15]	H[13]	F[13]	VSS_HV_IO	VSS_HV_IO
B	VSS_HV_IO/VSS_LV_COR	VDD_HV_IO	F[3]	D[2]	B[6]	F[0]	D[4]	D[0]	VSS_HV_IO	E[14]	A[10]	B[3]	H[9]	C[10]	J[3]	VDD_HV_IO	VSS_HV_IO
C	I[15]	J[0]	VSS_HV_IO	FCCU_F[1]	A[13]	I[0]	H[10]	E[15]	H[11]	I[14]	J[2]	B[2]	H[6]	B[1]	VSS_HV_IO	B[0]	H[15]
D	A[6]	I[7]	A[15]	C[6]	N/C	EXT_POR_B	A[12]	VDD_HV_IO	VSS_HV_IO	A[11]	I[2]	F[14]	J[4]	VDD_HV_IO	VPP_TE_ST	A[4]	F[12]
E	F[4]	F[6]	D[1]	NMI_B	-	-	-	-	-	-	-	-	-	N/C	C[13]	G[3]	D[14]
F	F[5]	H[7]	H[5]	H[4]	-	VDD_LV_COR	VDD_LV_COR	VDD_LV_COR	VDD_LV_COR	VDD_LV_COR	VDD_LV_COR	VDD_LV_COR	-	C[14]	D[12]	G[4]	G[2]
G	MDO0	VDD_HV_IO	C[5]	A[7]	-	VDD_LV_COR	VSS_LV_COR	VSS_LV_COR	VSS_LV_COR	VSS_LV_COR	VSS_LV_COR	VDD_LV_COR	-	B[4]	A[3]	J[8]	G[6]
H	A[8]	VSS_HV_IO	C[4]	A[5]	-	VDD_LV_COR	VSS_LV_COR	VSS_LV_COR	VSS_LV_COR	VSS_LV_COR	VSS_LV_COR	VDD_LV_COR	-	G[12]	TMS	VDD_HV_FL	TCK
J	C[7]	I[4]	F[8]	F[7]	-	VDD_LV_COR	VSS_LV_COR	VSS_LV_COR	VSS_LV_COR	VSS_LV_COR	VSS_LV_COR	VDD_LV_COR	-	G[13]	H[1]	VDD_LV_NEXUS	B[5]
K	J[9]	F[10]	F[9]	I[8]	-	VDD_LV_COR	VSS_LV_COR	VSS_LV_COR	VSS_LV_COR	VSS_LV_COR	VSS_LV_COR	VDD_LV_COR	-	G[15]	H[0]	VSS_LV_NEXUS	J[10]
L	H[8]	F[11]	I[9]	D[8]	-	VDD_LV_COR	VSS_LV_COR	VSS_LV_COR	VSS_LV_COR	VSS_LV_COR	VSS_LV_COR	VDD_LV_COR	-	A[2]	G[14]	N/C	J[11]
M	VDD_HV_OSC	VDD_HV_IO	I[10]	D[5]	-	VDD_LV_COR	VDD_LV_COR	VDD_LV_COR	VDD_LV_COR	VDD_LV_COR	VDD_LV_COR	VDD_LV_COR	-	C[12]	I[6]	G[7]	G[5]
N	XTAL	VSS_HV_IO	D[9]	VSS_LV_PLL	-	-	-	-	-	-	-	-	-	G[8]	I[5]	VDD_LV_LFAST	VSS_LV_LFAST
P	VSS_HV_OSC	RESET_B	D[6]	VDD_LV_PLL	I[12]	I[13]	B[8]	J[5]	J[6]	J[7]	B[14]	A[0]	H[14]	G[9]	N/C	C[11]	D[11]
R	EXTAL	FCCU_F[0]	VSS_HV_IO	D[7]	B[7]	E[6]	VDD_HV_ADRE0	B[10]	VDD_HV_ADRE1	B[13]	B[15]	C[0]	BCTRL	N/C	VSS_HV_IO	D[10]	G[10]
T	VSS_HV_IO	VDD_HV_IO	I[1]	C[1]	E[5]	E[7]	VSS_HV_ADRE0	B[11]	VSS_HV_ADRE1	VDD_HV_ADV	E[10]	E[12]	E[0]	A[1]	G[11]	VDD_HV_IO	VSS_HV_IO
U	VSS_HV_IO	VSS_HV_IO	I[11]	E[4]	C[2]	E[2]	B[9]	B[12]	VSS_HV_ADV	E[9]	E[11]	N/C	N/C	VDD_HV_PMU/IO	N/C	VSS_HV_IO	VSS_HV_IO

Figure 3. 257MAPBGA ballmap

2.2 Pin/ball descriptions

The following sections provide signal descriptions and related information about the functionality and configuration of the device. Note that this section is under development.

2.2.1 Pin/ball startup and reset states

The following table provides startup state and reset state information for device pins/balls.

The startup state and subsequent states of the following pins/balls cannot be configured by the user:

- JCOMP
- TMS
- TCK
- XTAL/EXTAL
- FCCU_F[0] and FCCU_F[1]
- EXT_POR_B
- RESET_B

The user can configure the state after reset of the following pins/balls by programming the applicable MSCRs/IMCRs:

- GPIOs
- Analog inputs
- TDI
- TDO
- NMI_B
- FAB
- ABS[0]
- ABS[2]

Table 3. Pin/ball startup and reset states

Pin/ball	Startup state ^{1, 2}	State during reset	State after reset	144LQFP	257MAPBGA
GPIOs	hi-z	hi-z	hi-z	Note ³	Note ³
Analog inputs ⁴	hi-z	hi-z	hi-z	Note ³	Note ³
JCOMP (TRST)	hi-z	input, weak pull-down	input, weak pull-down	Note ⁵	Note ⁵
TDI	hi-z	input, weak pull-up	input, weak pull-up	Note ⁵	Note ⁵
TDO	hi-z	output, hi-z	output, hi-z	Note ⁵	Note ⁵
TMS ⁶	hi-z	input, weak pull-up	input, weak pull-up	Note ⁵	Note ⁵

Table continues on the next page...

Table 3. Pin/ball startup and reset states (continued)

Pin/ball	Startup state ^{1, 2}	State during reset	State after reset	144LQFP	257MAPBGA
TCK ⁶	hi-z	input, weak pull-up	input, weak pull-up	Note ⁵	Note ⁵
XTAL/EXTAL	hi-z	hi-z	hi-z	Note ⁵	Note ⁵
FCCU_F[0] ⁶	hi-z	input, hi-z	output/input, hi-z	38	R2
FCCU_F[1] ⁶	hi-z	input, hi-z	output/input, hi-z	141	C4
EXT_POR_B	hi-z	input, weak pull-down	input, weak pull-down	Note ⁵	Note ⁵
RESET_B	hi-z	input, weak pull-down	input, weak pull-down	Note ⁵	Note ⁵
NMI_B	hi-z	input, weak pull-up	input, weak pull-up	Note ⁵	Note ⁵
FAB	hi-z	input, weak pull-down	input, weak pull-down	Note ⁵	Note ⁵
ABS[2]	hi-z	input, weak pull-down	input, weak pull-down	Note ⁵	Note ⁵
ABS[0]	hi-z	input, weak pull-down	input, weak pull-down	Note ⁵	Note ⁵

1. Startup state is exited when the core and high-voltage supplies reach minimum levels.
2. Pads marked "high impedance" for POR will be in either high-impedance or weak low drive state when VDD_LV_CORE is off and HV_VDD_IO is below 1.5 V.
3. See [Generic pins/balls](#).
4. Not all non-supply or reference pins on the device are explicitly defined in this table.
5. See [System pins/balls](#).
6. This pin/ball is dedicated to and directly connected to a peripheral module pin.

2.2.2 Power supply and reference voltage pins/balls

Table 4. Power supply and reference voltage pins/balls

Supply			Package	
Symbol	Type	Description	144LQFP	257MAPBGA
V _{DD_LV_COR}	Power	Low voltage power Supply	18	F6
			39	F7
			70	F8
			93	F9
			131	F10
			135	F11
				F12
				G6
				G12
				H6
				H12
				J6
	J12			
	K6			
	K12			

Table continues on the next page...

Table 4. Power supply and reference voltage pins/balls (continued)

Supply			Package	
Symbol	Type	Description	144LQFP	257MAPBGA
				L6 L12 M6 M7 M8 M9 M10 M11 M12
V _{SS_LV_COR}	Ground	Low voltage ground. PLL Ground is also connected to low voltage ground for core logic on 144LQFP (pin 35).	17 35 40 71 94 96 132 137	B1 G7 G8 G9 G10 G11 H7 H8 H9 H10 H11 J7 J8 J9 J10 J11 K7 K8 K9 K10 K11 L7 L8 L9 L10 L11
V _{DD_LV_PLL}	Power	PLL low voltage Supply	36	P4
V _{SS_LV_PLL}	Ground	PLL low voltage Ground	35	N4

Table continues on the next page...

Table 4. Power supply and reference voltage pins/balls (continued)

Supply			Package	
Symbol	Type	Description	144LQFP	257MAPBGA
V _{DD_HV_IO}	Power	High voltage Power Supply for I/O	6	A9
			21	B2
			72	B16
			91	D8
			126	D14
			G2	
			M2	
			T2	
			T16	
			U14	
V _{SS_HV_IO}	Ground	High voltage Ground Supply for I/O	7	A1
			22	A2
			90	A16
			127	A17
				B1
				B9
				B17
				C3
				C15
				D9
				H2
				N2
				R3
				R15
				T1
				T17
				U1
	U2			
	U16			
	U17			
V _{DD_HV_PMU}	Power	PMU high voltage Supply	72	U14
V _{DD_HV_PMU_AUX}				
V _{DD_HV_OSC}	Power	Power Supply for the oscillator	27	M1
V _{SS_HV_OSC}	Ground	Ground Supply for the oscillator	28	P1
V _{DD_HV_FLA}	Power	Power Supply and decoupling pin for flash memory	97	H16
V _{DD_HV_ADV}	Power	High voltage Supply for ADC, TSSENS, SGEN (3.3 V)	58	T10
V _{SS_HV_ADV}	Ground	High voltage Ground for ADC	59	U9

Table continues on the next page...

Table 4. Power supply and reference voltage pins/balls (continued)

Supply			Package	
Symbol	Type	Description	144LQFP	257MAPBGA
V _{DD_HV_ADRE0}	Supply	High voltage Supply for digital portion of ADC pads Voltage reference of ADC/TSENS High voltage Supply for ADC0 pads and shared pads for ADC0/1.	50	R7
V _{SS_HV_ADRE0}	Ground	High voltage Ground for digital portion of ADC pads Voltage reference Ground of ADC/TSENS High voltage Ground for ADC0 pads and shared pads for ADC0/1.	51	T7
V _{DD_HV_ADRE1}	Supply	High voltage Supply for digital portion of ADC pads Voltage reference of ADC/TSENS High voltage Supply for ADC1 pads, shared pads for ADC1/3, and shared pads for ADC2/3.	56	R9
V _{SS_HV_ADRE1}	Ground	High voltage Ground for digital portion of ADC pads Voltage reference Ground of ADC/TSENS High voltage Ground for ADC1 pads, shared pads for ADC1/3, and shared pads for ADC2/3.	57	T9
V _{DD_LV_LFAST}	Supply	LFAST PLL low voltage Supply	—	N16
V _{SS_LV_LFAST}	Ground	LFAST PLL low voltage Ground	—	N17
V _{DD_LV_NEXUS}	Supply	Aurora LVDS Supply	—	J16
V _{SS_LV_NEXUS}	Ground	Aurora LVDS Ground	—	K16

2.2.3 System pins/balls

The following table contains information about system pin functions for the devices.

Table 5. System pins/balls

Symbol	Type	Description	144LQFP	257MAPBGA
NMI_B	Input	Non-maskable Interrupt	1	E4
XTAL	Output	Output of the oscillator amplifier circuit	29	N1
EXTAL	Input	Crystal oscillator input/external clock input	30	R1
RESET_B	Input	Functional Reset	31	P2
EXT_POR_B	Input	External Power On Reset	130	D6
VPP_TEST ¹	Input	SoC Test Mode	107	D15
JCOMP	Input	JTAGC, JTAG Compliance Enable	123	A6
TCK	Input	JTAGC, Test Clock Input	88	H17
TMS	Input	JTAGC, Test Mode Select	87	H15
TDO	Output	JTAGC, Test Data Out	89	G14

Table continues on the next page...

Table 5. System pins/balls (continued)

Symbol	Type	Description	144LQFP	257MAPBGA
TDI	Input	JTAGC, Test Data Input	86	J17
MDO[0]	Output	NEXUS, Message data out pins; reflects the state of the internal power on reset signal until RESET is negated	9	G1
MDO[3:1]	Output	NEXUS, Message data out pins	4,5,8	E1, F1, E2
EVTO	Output	NEXUS, Event Out Pin	24	K2
EVTI	Input	NEXUS, Event In Pin	25	L2
MCKO	Output	NEXUS, Message clock out pin	19	J4
MSEO[1:0]	Output	NEXUS, Message Start/End out pin	20, 23	J3, K3
RDY_B	Output	NEXUS, Read/Write Transfer completed	— 16	J2 K1
BCTRL	Output	Base control signal of external npn ballast	69	R13
J[11], J[10]	--	FSL Factory Test ²	—	L17, K17

1. VPP_TEST must be connected to ground.
2. Do not connect on the board.

2.2.4 LVDS pins/balls

The following tables contain information on LVDS pin functions for the devices.

Table 6. SIPI LFAST LVDS pin descriptions

Functional block	Port pin	Signal	Signal description	Direction	257MAPBGA
SIPI LFAST ^{1,2}	I[5]	LFAST_TX N	SIPI/ LFAST, LVDS Transmit Negative Terminal	O	N15
	C[12] ³	LFAST_TX P	SIPI/ LFAST, LVDS Transmit Positive Terminal	O	M14
	I[6]	LFAST_RX N	SIPI/ LFAST, LVDS Receive Negative Terminal	I	M15
	G[7] ³	LFAST_RX P	SIPI/ LFAST, LVDS Receive Positive Terminal	I	M16

1. DRCLK and TCK/DRCLK usage for SIPI LFAST are described in the reference manual's SIPI LFAST chapters.
2. For the MSCR SSS value of the port pin, see [Table 1](#).
3. The 144LQFP package has G[7] and C[12] but no SIPI LFAST functionality.

CAUTION

SIPI LFAST pins are muxed with GPIOs. Do not use GPIO and SIPI LFAST functionality in parallel.

Table 7. Aurora LVDS pin descriptions

Functional block	Pad	Signal	Signal description	Direction	257MAPBGA ¹
Nexus Aurora High Speed Trace	G[12]	TX0P	Nexus Aurora High Speed Trace Lane 0, LVDS Positive Terminal	O	H14
	G[13]	TX0N	Nexus Aurora High Speed Trace Lane 0, LVDS Negative Terminal	O	J14
	G[14]	TX1P	Nexus Aurora High Speed Trace Lane 1, LVDS Positive Terminal	O	L15
	G[15]	TX1N	Nexus Aurora High Speed Trace Lane 1, LVDS Negative Terminal	O	K14
	H[0]	CLKP	Nexus Aurora High Speed Trace Clock, LVDS Positive Terminal	I	K15
	H[1]	CLKN	Nexus Aurora High Speed Trace Clock, LVDS Negative Terminal	I	J15

1. Nexus Aurora High Speed Trace is available only on the 257MAPBGA.

2.2.5 Generic pins/balls

The I/O signal descriptions for the device are in the following table. It contains the port definition, multiplexing, direction, pad type, and package pin/ball numbers for each I/O pin on the device.

MSCR registers are used for alternative (ALT) mode selection and programming of pad control options.

IMCR registers are used to configure input muxing by peripheral. See [Peripheral input muxing](#) for details.

For the pins which have Nexus functionality muxed with GPIO or other functions, the Nexus functionality of such pins is automatically set when the Nexus tool is connected to the device. The value in MSCR register may have value that does not correspond to Nexus functionality.

Table 8. Pin muxing

Port Pin	SIUL2 MSCR/ IMCR Number	MSCR/ IMCR SSS Value ¹	Signal	Module	Short Signal Description	Dir	LQFP144	BGA257
A[0]	MSCR[0]	0000 (Default) ²	GPIO[0]	SIUL2-GPIO[0]	General Purpose IO A[0]	I/O	73	P12
		0001	ETC0	eTimer_0	eTimer_0 Input/Output Data Channel 0	I/O		
		0010	SCK	DSPI2	DSPI 2 Input/Output Serial Clock	I/O		

Table continues on the next page...

Table 8. Pin muxing (continued)

Port Pin	SIUL2 MSCR/ IMCR Number	MSCR/ IMCR SSS Value ¹	Signal	Module	Short Signal Description	Dir	LQFP144	BGA257
		0011-1111	—	Reserved	—	—		
	IMCR[48]	0001	SCK	DSPI2	DSPI 2 Input Serial Clock	I		
	IMCR[59]	0010	ETC0	eTimer_0	eTimer_0 Input Data Channel 0	I		
	IMCR[173]	0001	REQ0	SIUL2	SIUL2 External Interrupt 0	I		
A[1]	MSCR[1]	0000 (Default)	GPIO[1]	SIUL2-GPIO[1]	General Purpose IO A[1]	I/O	74	T14
		0001	ETC1	eTimer_0	eTimer_0 Input/Output Data Channel 1	I/O		
		0010	SOUT	DSPI2	DSPI 2 Serial Data Out	O		
		0011-1111	—	Reserved	—	—		
	IMCR[60]	0010	ETC1	eTimer_0	eTimer_0 Input Data Channel 1	I		
	IMCR[174]	0001	REQ1	SIUL2	SIUL2 External Interrupt Source 1	I		
A[2]	MSCR[2]	0000 (Default)	GPIO[2]	SIUL2-GPIO[2]	General Purpose IO A[2]	I/O	84	L14
		0001	ETC2	eTimer_0	eTimer_0 Input/Output Data Channel 2	I/O		
		0010	—	Reserved	—	—		
		0011	A3	FlexPWM_0	FlexPWM_0 Channel A Input/Output 3	I/O		
		0100-1111	—	Reserved	—	—		
	IMCR[169]	0000 (Default)	ABS0	MC_RGM	RGM external boot mode 1	I		
	IMCR[47]	0010	SIN	DSPI2	DSPI 2 Serial Data Input	I		
	IMCR[61]	0010	ETC2	eTimer_0	eTimer_0 Input Data Channel 2	I		
	IMCR[97]	0001	A3	FlexPWM_0	FlexPWM_0 Channel A Input 3	I		
	IMCR[175]	0001	REQ2	SIUL2	SIUL2 External Interrupt Source 2	I		
A[3]	MSCR[3]	0000 (Default)	GPIO[3]	SIUL2-GPIO[3]	General Purpose IO A[3]	I/O	92	G15
		0001	ETC3	eTimer_0	eTimer_0 Input/Output Data Channel 3	I/O		
		0010	CS0	DSPI2	DSPI 2 Peripheral Chip Select 0	I/O		
		0011	B3	FlexPWM_0	FlexPWM_0 Channel B Input/Output 3	I/O		
		0100-1111	—	Reserved	—	—		
	IMCR[171]	0000 (Default)	ABS2	MC_RGM	RGM external boot mode 2	I		
	IMCR[62]	0010	ETC3	eTimer_0	eTimer_0 Input Data Channel 3	I		

Table continues on the next page...

Table 8. Pin muxing (continued)

Port Pin	SIUL2 MSCR/ IMCR Number	MSCR/ IMCR SSS Value ¹	Signal	Module	Short Signal Description	Dir	LQFP144	BGA257
	IMCR[49]	0001	CS0	DSPI2	DSPI 2 Peripheral Chip Select 0	I		
	IMCR[98]	0001	B3	FlexPWM_0	FlexPWM_0 Channel B Input 3	I		
	IMCR[176]	0001	REQ3	SIUL2	SIUL2 External Interrupt Source 3	I		
A[4]	MSCR[4]	0000 (Default)	GPIO[4]	SIUL2-GPIO[4]	General Purpose IO A[4]	I/O	108	D16
		0001	ETC0	eTimer_1	eTimer_1 Input/Output Data Channel 0	I/O		
		0010	CS1	DSPI2	DSPI 2 Peripheral Chip Select 1	O		
		0011	ETC4	eTimer_0	eTimer_0 Input/Output Data Channel 4	I/O		
		0100	A2	FlexPWM_1	FlexPWM_1 Channel A Input/Output 2	I/O		
		0101-1111	—	Reserved	—	—		
	IMCR[112]	0001	A2	FlexPWM_1	FlexPWM_1 Channel A Input 2	I		
	IMCR[177]	0001	REQ4	SIUL2	SIUL2 External Interrupt Source 4	I		
	IMCR[172]	0000 (Default)	FAB	MC_RGM	RGM Force Alternate Boot Mode	I		
	IMCR[65]	0001	ETC0	eTimer_1	eTimer_1 Input Data Channel 0	I		
	IMCR[63]	0011	ETC4	eTimer_0	eTimer_0 Input Data Channel 4	I		
A[5]	MSCR[5]	0000 (Default)	GPIO[5]	SIUL2-GPIO[5]	General Purpose IO A[5]	I/O	14	H4
		0001	CS0	DSPI1	DSPI 1 Peripheral Chip Select 0	I/O		
		0010	ETC5	eTimer_1	eTimer_1 Input/Output Data Channel 5	I/O		
		0011	CS7	DSPI0	DSPI 0 Peripheral Chip Select 7	O		
		0100-1111	—	Reserved	—	—		
	IMCR[70]	0001	ETC5	eTimer_1	eTimer_1 Input Data Channel 5	I		
	IMCR[178]	0001	REQ5	SIUL2	SIUL2 External Interrupt Source 5	I		
A[6]	MSCR[6]	0000 (Default)	GPIO[6]	SIUL2-GPIO[6]	General Purpose IO A[6]	I/O	2	D1
		0001	SCK	DSPI1	DSPI 1 Input/Output Serial Clock	I/O		
		0010	ETC2	eTimer_2	eTimer_2 Input/Output Data Channel 2	I/O		
		0011-1111	—	Reserved	—	—		

Table continues on the next page...

Table 8. Pin muxing (continued)

Port Pin	SIUL2 MSCR/ IMCR Number	MSCR/ IMCR SSS Value ¹	Signal	Module	Short Signal Description	Dir	LQFP144	BGA257
	IMCR[73]	0001	ETC2	eTimer_2	eTimer_2 Input Data Channel 2	I		
	IMCR[179]	0001	REQ6	SIUL2	SIUL2 External Interrupt Source 6	I		
A[7]	MSCR[7]	0000 (Default)	GPIO[7]	SIUL2-GPIO[7]	General Purpose IO A[7]	I/O	10	G4
		0001	SOUT	DSPI1	DSPI 1 Serial Data Out	O		
		0010	ETC3	eTimer_2	eTimer_2 Input/Output Data Channel 3	I/O		
		0011-1111	—	Reserved	—	—		
	IMCR[74]	0001	ETC3	eTimer_2	eTimer_2 Input Data Channel 3	I		
	IMCR[180]	0001	REQ7	SIUL2	SIUL2 External Interrupt Source 7	I		
A[8]	MSCR[8]	0000 (Default)	GPIO[8]	SIUL2-GPIO[8]	General Purpose IO A[8]	I/O	12	H1
		0001	—	Reserved	—	—		
		0010	ETC4	eTimer_2	eTimer_2 Input/Output Data Channel 4	I/O		
		0011-1111	—	Reserved	—	—		
	IMCR[44]	0001	SIN	DSPI1	DSPI 1 Serial Data Input	I		
	IMCR[75]	0001	ETC4	eTimer_2	eTimer_2 Input Data Channel 4	I		
	IMCR[181]	0001	REQ8	SIUL2	SIUL2 External Interrupt Source 8	I		
A[9]	MSCR[9]	0000 (Default)	GPIO[9]	SIUL2-GPIO[9]	General Purpose IO A[9]	I/O	134	A4
		0001	CS1	DSPI2	DSPI 2 Peripheral Chip Select 1	O		
		0010	ETC5	eTimer_2	eTimer_2 Input/Output Data Channel 5	I/O		
		0011	B3	FlexPWM_0	FlexPWM_0 Channel B Input/Output 3	I/O		
		0100-1111	—	Reserved	—	—		
	IMCR[76]	0001	ETC5	eTimer_2	eTimer_2 Input Data Channel 5	I		
	IMCR[98]	0010	B3	FlexPWM_0	FlexPWM_0 Channel B Input 3	I		
	IMCR[83]	0001	FAULT0	FlexPWM_0	FlexPWM_0 Fault Input 0	I		
	IMCR[206]	0011	SENT_RX[1]	SENT_0	SENT 0 Receiver channel 1	I		
A[10]	MSCR[10]	0000 (Default)	GPIO[10]	SIUL2-GPIO[10]	General Purpose IO A[10]	I/O	118	B11
		0001	CS0	DSPI2	DSPI 2 Peripheral Chip Select 0	O		
		0010	B0	FlexPWM_0	FlexPWM_0 Channel B Input/Output 0	I/O		

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Table 8. Pin muxing (continued)

Port Pin	SIUL2 MSCR/IMCR Number	MSCR/IMCR SSS Value ¹	Signal	Module	Short Signal Description	Dir	LQFP144	BGA257
		0011	X2	FlexPWM_0	FlexPWM_0 Auxiliary Input/Output 2	I/O		
		0100-1111	—	Reserved	—	—		
	IMCR[49]	0010	CS0	DSPI2	DSPI 2 Peripheral Chip Select 0	I/O		
	IMCR[89]	0001	B0	FlexPWM_0	FlexPWM_0 Channel B Input 0	I		
	IMCR[96]	0001	X2	FlexPWM_0	FlexPWM_0 Auxiliary Input 2	I		
	IMCR[182]	0001	REQ9	SIUL2	SIUL2 External Interrupt Source 9	I		
	IMCR[214]	0011	SENT_RX[1]	SENT_1	SENT 1 Receiver channel 1	I		
A[11]	MSCR[11]	0000 (Default)	GPIO[11]	SIUL2-GPIO[11]	General Purpose IO A[11]	I/O	120	D10
		0001	SCK	DSPI2	DSPI 2 Input/Output Serial Clock	I/O		
		0010	A0	FlexPWM_0	FlexPWM_0 Channel A Input/Output 0	I/O		
		0011	A2	FlexPWM_0	FlexPWM_0 Channel A Input/Output 2	I/O		
		0100-1111	—	Reserved	—	—		
	IMCR[48]	0010	SCK	DSPI2	DSPI 2 Input Serial Clock	I		
	IMCR[88]	0001	A0	FlexPWM_0	FlexPWM_0 Channel A Input 0	I		
	IMCR[94]	0001	A2	FlexPWM_0	FlexPWM_0 Channel A Input 2	I		
	IMCR[183]	0001	REQ10	SIUL2	SIUL2 External Interrupt Source 10	I		
A[12]	MSCR[12]	0000 (Default)	GPIO[12]	SIUL2-GPIO[12]	General Purpose IO A[12]	I/O	122	D7
		0001	SOUT	DSPI2	DSPI 2 Serial Data Out	O		
		0010	A2	FlexPWM_0	FlexPWM_0 Channel A Input/Output 2	I/O		
		0011	B2	FlexPWM_0	FlexPWM_0 Channel B Input/Output 2	I/O		
		0100-1111	—	Reserved	—	—		
	IMCR[94]	0010	A2	FlexPWM_0	FlexPWM_0 Channel A Input 2	I		
	IMCR[95]	0001	B2	FlexPWM_0	FlexPWM_0 Channel B Input 2	I		
	IMCR[184]	0001	REQ11	SIUL2	SIUL2 External Interrupt Source 11	I		
A[13]	MSCR[13]	0000 (Default)	GPIO[13]	SIUL2-GPIO[13]	General Purpose IO A[13]	I/O	136	C5
		0001	—	Reserved	—	—		
		0010	B2	FlexPWM_0	FlexPWM_0 Channel B Input/Output 2	I/O		

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Table 8. Pin muxing (continued)

Port Pin	SIUL2 MSCR/IMCR Number	MSCR/IMCR SSS Value ¹	Signal	Module	Short Signal Description	Dir	LQFP144	BGA257
		0011-1111	—	Reserved	—	—		
	IMCR[83]	0010	FAULT0	FlexPWM_0	FlexPWM_0 Fault Input 0	I		
	IMCR[95]	0010	B2	FlexPWM_0	FlexPWM_0 Channel B Input 2	I		
	IMCR[47]	0001	SIN	DSPI2	DSPI 2 Serial Data Input	I		
	IMCR[185]	0001	REQ12	SIUL2	SIUL2 External Interrupt Source 12	I		
A[14]	MSCR[14]	0000 (Default)	GPIO[14]	SIUL2-GPIO[14]	General Purpose IO A[14]	I/O	143	A3
		0001	TXD	CAN1	CAN 1 Transmit Pin	O		
		0010	ETC4	eTimer_1	eTimer_1 Input/Output Data Channel 4	I/O		
		0011-1111	—	Reserved	—	—		
	IMCR[69]	0001	ETC4	eTimer_1	eTimer_1 Input Data Channel 4	I		
	IMCR[186]	0001	REQ13	SIUL2	SIUL2 External Interrupt Source 13	I		
A[15]	MSCR[15]	0000 (Default)	GPIO[15]	SIUL2-GPIO[15]	General Purpose IO A[15]	I/O	144	D3
		0001	—	Reserved	—	—		
		0010	ETC5	eTimer_1	eTimer_1 Input/Output Data Channel 5	I/O		
		0011-1111	—	Reserved	—	—		
	IMCR[32]	0001	RXD	CAN0	CAN 0 Receive Pin	I		
	IMCR[33]	0001	RXD	CAN1	CAN 1 Receive Pin	I		
	IMCR[70]	0010	ETC5	eTimer_1	eTimer_1 Input Data Channel 5	I		
	IMCR[187]	0001	REQ14	SIUL2	SIUL2 External Interrupt Source 14	I		
B[0]	MSCR[16]	0000 (Default)	GPIO[16]	SIUL2-GPIO[16]	General Purpose IO B[0]	I/O	109	C16
		0001	TXD	CAN0	CAN 0 Transmit Pin	O		
		0010	ETC2	eTimer_1	eTimer_1 Input/Output Data Channel 2	I/O		
		0011	DEBUG0	SSCM	SSCM Debug Output 0	O		
		0100-1111	—	Reserved	—	—		
	IMCR[67]	0001	ETC2	eTimer_1	eTimer_1 Input Data Channel 2	I		
	IMCR[188]	0001	REQ15	SIUL2	SIUL2 External Interrupt Source 15	I		
B[1]	MSCR[17]	0000 (Default)	GPIO[17]	SIUL2-GPIO[17]	General Purpose IO B[1]	I/O	110	C14
		0001	—	Reserved	—	—		
		0010	ETC3	eTimer_1	eTimer_1 Input/Output Data Channel 3	I/O		

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Table 8. Pin muxing (continued)

Port Pin	SIUL2 MSCR/ IMCR Number	MSCR/ IMCR SSS Value ¹	Signal	Module	Short Signal Description	Dir	LQFP144	BGA257
		0011	DEBUG1	SSCM	SSCM Debug Output 1	O		
		0100-1111	—	Reserved	—	—		
	IMCR[32]	0010	RXD	CAN0	CAN 0 Receive Pin	I		
	IMCR[33]	0010	RXD	CAN1	CAN 1 Receive Pin	I		
	IMCR[68]	0001	ETC3	eTimer_1	eTimer_1 Input Data Channel 3	I		
	IMCR[189]	0001	REQ16	SIUL2	SIUL2 External Interrupt Source 16	I		
B[2]	MSCR[18]	0000 (Default)	GPIO[18]	SIUL2- GPIO[18]	General Purpose IO B[2]	I/O	114	C12
		0001	TXD	LIN0	LINFlexD 0 Transmit Pin	O		
		0010	CS4	DSPI0	DSPI 0 Peripheral Chip Select 4	O		
		0011	DEBUG2	SSCM	SSCM Debug Output 2	O		
		0100-1111	—	Reserved	—	—		
		IMCR[190]	0001	REQ17	SIUL2	SIUL2 External Interrupt Source 17		
B[3]	MSCR[19]	0000 (Default)	GPIO[19]	SIUL2- GPIO[19]	General Purpose IO B[3]	I/O	116	B12
		0001	—	Reserved	—	—		
		0010	CS5	DSPI0	DSPI 0 Peripheral Chip Select 5	O		
		0011	DEBUG3	SSCM	SSCM Debug Output 3	O		
		0100-1111	—	Reserved	—	—		
		IMCR[165]	0001	RXD	LIN0	LIN 0 Receive Pin		
B[4]	MSCR[20]	0	GPIO[20]	SIUL2- GPIO[20]	General Purpose IO B[4]	I/O	89	G14
		0001 (Default)	TDO	NPC_HNDSHK	NPC_HNDSHK Test Data Out (TDO)	O		
		0010-1111	—	Reserved	—	—		
B[5]	MSCR[21]	0000 (Default)	GPIO[21]	SIUL2- GPIO[21]	JTAGC Test Data In (TDI) ³ General Purpose IO B[5]	I/O	86	J17
		0001	CS7	DSPI0	DSPI 0 Peripheral Chip Select 7	O		
		0010-1111	—	Reserved	—	—		
B[6]	MSCR[22]	0000 (Default)	GPIO[22]	SIUL2- GPIO[22]	General Purpose IO B[6]	I/O	138	B5
		0001	CLK_OUT	MC_CGM	CGM Clock out for off-chip use and observation	O		
		0010	CS2	DSPI2	DSPI 2 Peripheral Chip Select 2	O		
		0011-1111	—	Reserved	—	—		

Table continues on the next page...

Table 8. Pin muxing (continued)

Port Pin	SIUL2 MSCR/IMCR Number	MSCR/IMCR SSS Value ¹	Signal	Module	Short Signal Description	Dir	LQFP144	BGA257
	IMCR[191]	0001	REQ18	SIUL2	SIUL2 External Interrupt Source 18	I		
B[7]	MSCR[23]	0000 (Default)	GPI[23] ⁴ ADC0_AN[0]	SIUL2-GPI[23]	General Purpose Input B[7]	I	43	R5
		0001	—	Reserved	—	—		
		0010-1111	—	Reserved	—	—		
	IMCR[165]	0010	RXD	LIN0	LIN 0 Receive Pin	I		
B[8]	MSCR[24]	0	GPI[24] ⁴ ADC0_AN[1]	SIUL2-GPI[24]	General Purpose Input B[8]	I	47	P7
		0001	—	Reserved	—	—		
		0010-1111	—	Reserved	—	—		
	IMCR[64]	0001	ETC5	eTimer_0	eTimer_0 Input Data Channel 5	I		
B[9]	MSCR[25]	0000 (Default)	GPI[25] ⁴ ADC0_ADC1_AN[11]	SIUL2-GPI[25]	General Purpose Input B[9]	I	52	U7
		0001	—	Reserved	—	—		
		0010-1111	—	Reserved	—	—		
B[10]	MSCR[26]	0000 (Default)	GPI[26] ⁴ ADC0_ADC1_AN[12]	SIUL2-GPI[26]	General Purpose Input B[10]	I	53	R8
		0001	—	Reserved	—	—		
		0010-1111	—	Reserved	—	—		
B[11]	MSCR[27]	0000 (Default)	GPI[27] ⁴ ADC0_ADC1_AN[13]	SIUL2-GPI[27]	General Purpose Input B[11]	I	54	T8
		0001	—	Reserved	—	—		
		0010-1111	—	Reserved	—	—		
B[12]	MSCR[28]	0000 (Default)	GPI[28] ⁴ ADC0_ADC1_AN[14]	SIUL2-GPI[28]	General Purpose Input B[12]	I	55	U8
		0001	—	Reserved	—	—		
		0010-1111	—	Reserved	—	—		
B[13]	MSCR[29]	0000 (Default)	GPI[29] ⁴ ADC1_AN[0]	SIUL2-GPI[29]	General Purpose Input B[13]	I	60	R10
		0001	—	Reserved	—	—		
		0010-1111	—	Reserved	—	—		
	IMCR[166]	0001	RXD	LIN1	LIN 1 Receive Pin	I		
B[14]	MSCR[30]	0000 (Default)	GPI[30] ⁴ ADC1_AN[1]	SIUL2-GPI[30]	General Purpose Input B[14]	I	64	P11
		0001	—	Reserved	—	—		
		0010-1111	—	Reserved	—	—		

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Table 8. Pin muxing (continued)

Port Pin	SIUL2 MSCR/IMCR Number	MSCR/IMCR SSS Value ¹	Signal	Module	Short Signal Description	Dir	LQFP144	BGA257
	IMCR[63]	0001	ETC4	eTimer_0	eTimer_0 Input Data Channel 4	I		
	IMCR[192]	0001	REQ19	SIUL2	SIUL2 External Interrupt Source 19	I		
B[15]	MSCR[31]	0000 (Default)	GPI[31] ⁴ ADC1_AN[2]	SIUL2-GPI[31]	General Purpose Input B[15]	I	62	R11
		0001	—	Reserved	—	—		
		0010-1111	—	Reserved	—	—		
	IMCR[193]	0001	REQ20	SIUL2	SIUL2 External Interrupt Source 20	I		
C[0]	MSCR[32]	0000 (Default)	GPI[32] ⁴ ADC1_AN[3]	SIUL2-GPI[32]	General Purpose Input C[0]	I	66	R12
		0001	—	Reserved	—	—		
		0010-1111	—	Reserved	—	—		
C[1]	MSCR[33]	0000 (Default)	GPI[33] ⁴ ADC0_AN[2]	SIUL2-GPI[33]	General Purpose Input C[1]	I	41	T4
		0001	—	Reserved	—	—		
		0010-1111	—	Reserved	—	—		
C[2]	MSCR[34]	0000 (Default)	GPI[34] ⁴ ADC0_AN[3]	SIUL2-GPI[34]	General Purpose Input C[2]	I	45	U5
		0001	—	Reserved	—	—		
		0010-1111	—	Reserved	—	—		
C[4]	MSCR[36]	0000 (Default)	GPIO[36]	SIUL2-GPIO[36]	General Purpose IO C[4]	I/O	11	H3
		0001	CS0	DSPI0	DSPI 0 Peripheral Chip Select 0	I/O		
		0010	X1	FlexPWM_0	FlexPWM_0 Auxiliary Input/Output 1	I/O		
		0011	DEBUG4	SSCM	SSCM Debug Output 4	O		
		0100-1111	—	Reserved	—	—		
	IMCR[93]	0001	X1	FlexPWM_0	FlexPWM_0 Auxiliary Input 1	I		
	IMCR[195]	0001	REQ22	SIUL2	SIUL2 External Interrupt Source 22	I		
C[5]	MSCR[37]	0000 (Default)	GPIO[37]	SIUL2-GPIO[37]	General Purpose IO C[5]	I/O	13	G3
		0001	SCK	DSPI0	DSPI 0 Input/Output Serial Clock	I/O		
		0010	—	Reserved	—	—		
		0011	DEBUG5	SSCM	SSCM Debug Output 5	O		
		0100-1111	—	Reserved	—	—		
	IMCR[86]	0001	FAULT3	FlexPWM_0	FlexPWM_0 Fault Input 3	I		

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Table 8. Pin muxing (continued)

Port Pin	SIUL2 MSCR/ IMCR Number	MSCR/ IMCR SSS Value ¹	Signal	Module	Short Signal Description	Dir	LQFP144	BGA257
	IMCR[196]	0001	REQ23	SIUL2	SIUL2 External Interrupt Source 23	I		
C[6]	MSCR[38]	0000 (Default)	GPIO[38]	SIUL2-GPIO[38]	General Purpose IO C[6]	I/O	142	D4
		0001	SOUT	DSPI0	DSPI 0 Serial Data Out	O		
		0010	B1	FlexPWM_0	FlexPWM_0 Channel B Input/Output 1	I/O		
		0011	DEBUG6	SSCM	SSCM Debug Output 6	O		
		0100-1111	—	Reserved	—	—		
	IMCR[92]	0001	B1	FlexPWM_0	FlexPWM_0 Channel B Input 1	I		
	IMCR[197]	0001	REQ24	SIUL2	SIUL2 External Interrupt Source 24	I		
C[7]	MSCR[39]	0000 (Default)	GPIO[39]	SIUL2-GPIO[39]	General Purpose IO C[7]	I/O	15	J1
		0001	—	Reserved	—	—		
		0010	A1	FlexPWM_0	FlexPWM_0 Channel A Input/Output 1	I/O		
		0011	DEBUG7	SSCM	SSCM Debug Output 7	O		
		0100-1111	—	Reserved	—	—		
	IMCR[41]	0001	SIN	DSPI0	DSPI 0 Serial Data Input	I		
	IMCR[91]	0001	A1	FlexPWM_0	FlexPWM_0 Channel A Input 1	I		
C[10]	MSCR[42]	0000 (Default)	GPIO[42]	SIUL2-GPIO[42]	General Purpose IO C[10]	I/O	111	B14
		0001	CS2	DSPI2	DSPI 2 Peripheral Chip Select 2	O		
		0010	—	Reserved	—	—		
		0011	A3	FlexPWM_0	FlexPWM_0 Channel A Input/Output 3	I/O		
		0100-1111	—	Reserved	—	—		
	IMCR[84]	0001	FAULT1	FlexPWM_0	FlexPWM_0 Fault Input 1	I		
	IMCR[97]	0010	A3	FlexPWM_0	FlexPWM_0 Channel A Input 3	I		
C[11]	MSCR[43]	0000 (Default)	GPIO[43]	SIUL2-GPIO[43]	General Purpose IO C[11]	I/O	80	P16
		0001	ETC4	eTimer_0	eTimer_0 Input/Output Data Channel 4	I/O		
		0010	CS2	DSPI2	DSPI 2 Peripheral Chip Select 2	O		
		0011	TX_ER	ENET_0	Ethernet transmit Data Error	O		
		0100	CS0	DSPI3	DSPI 3 Peripheral Chip Select 0	I/O		
		0101-1111	—	Reserved	—	—		

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Table 8. Pin muxing (continued)

Port Pin	SIUL2 MSCR/ IMCR Number	MSCR/ IMCR SSS Value ¹	Signal	Module	Short Signal Description	Dir	LQFP144	BGA257
	IMCR[52]	0001	CS0	DSPI3	DSPI 3 Peripheral Chip Select 0 ^a	I		
	IMCR[63]	0100	ETC4	eTimer_0	eTimer_0 Input Data Channel 4	I		
C[12] ⁵	MSCR[44]	0000 (Default)	GPIO[44]	SIUL2-GPIO[44]	General Purpose IO C[12]	I/O	82	M14
		0001	ETC5	eTimer_0	eTimer_0 Input/Output Data Channel 5 ⁶	I/O		
		0010	CS3	DSPI2	DSPI 2 Peripheral Chip Select 3	O		
		0011	LFAST_TXP	LFAST	SIPI/LFAST LVDS transmit positive terminal	O		
		0100	CS1	DSPI3	DSPI 3 Peripheral Chip Select 1	O		
		0101-1111	—	Reserved	—	—		
	IMCR[213]	0100	SENT_RX[0]	SENT1	SENT 1 Receiver Channel 0	I		
	IMCR[64]	0011	ETC5	eTimer_0	eTimer_0 Input Data Channel 5	I		
C[13]	MSCR[45]	0000 (Default)	GPIO[45]	SIUL2-GPIO[45]	General Purpose IO C[13]	I/O	101	E15
		0001	ETC1	eTimer_1	eTimer_1 Input/Output Data Channel 1	I/O		
		0010-0011	—	Reserved	—	—		
		0100	A0	FlexPWM_1	FlexPWM_1 Channel A Input/Output 0	I/O		
		0101-1111	—	Reserved	—	—		
	IMCR[38]	0001	EXT_IN	CTU_0	CTU 0 External Trigger Input	I		
	IMCR[66]	0001	ETC1	eTimer_1	eTimer_1 Input Data Channel 1	I		
	IMCR[87]	0001	EXT_SYNC	FlexPWM_0	FlexPWM_0 External Trigger Input	I		
	IMCR[105]	0001	A0	FlexPWM_1	FlexPWM_1 Channel A Input 0	I		
C[14]	MSCR[46]	0000 (Default)	GPIO[46]	SIUL2-GPIO[46]	General Purpose IO C[14]	I/O	103	F14
		0001	ETC2	eTimer_1	eTimer_1 Input/Output Data Channel 2	I/O		
		0010	EXT_TGR	CTU_0	CTU0 External Trigger Output	O		
		0011	CS7	DSPI1	DSPI 1 Peripheral Chip Select 7	O		
		0100	B0	FlexPWM_1	FlexPWM_1 Channel B Input/Output 0	I/O		
		0101-1111	—	Reserved	—	—		
	IMCR[67]	0010	ETC2	eTimer_1	eTimer_1 Input Data Channel 2	I		
	IMCR[106]	0001	B0	FlexPWM_1	FlexPWM_1 Channel B Input 0	I		

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Table 8. Pin muxing (continued)

Port Pin	SIUL2 MSCR/IMCR Number	MSCR/IMCR SSS Value ¹	Signal	Module	Short Signal Description	Dir	LQFP144	BGA257
C[15]	MSCR[47]	0000 (Default)	GPIO[47]	SIUL2-GPIO[47]	General Purpose IO C[15]	I/O	124	A8
		0001	FR_A_TXEN	FLEXRAY	FlexRay Transmit Enable Channel A	O		
		0010	ETC0	eTimer_1	eTimer_1 Input/Output Data Channel 0	I/O		
		0011	A1	FlexPWM_0	FlexPWM_0 Channel A Input/Output 1	I/O		
		0100-1111	—	Reserved	—	—		
	IMCR[38]	0010	EXT_IN	CTU_0	CTU 0 External Trigger Input	I		
	IMCR[65]	0010	ETC0	eTimer_1	eTimer_1 Input Data Channel 0	I		
	IMCR[87]	0010	EXT_SYNC	FlexPWM_0	FlexPWM_0 External Sync Input	I		
	IMCR[91]	0010	A1	FlexPWM_0	FlexPWM_0 Channel A Input 1	I		
D[0]	MSCR[48]	0000 (Default)	GPIO[48]	SIUL2-GPIO[48]	General Purpose IO D[0]	I/O	125	B8
		0001	FR_A_TX	FLEXRAY	FlexRay Transmit Data Channel A	O		
		0010	ETC1	eTimer_1	eTimer_1 Input/Output Data Channel 1	I/O		
		0011	B1	FlexPWM_0	FlexPWM_0 Channel B Input/Output 1	I/O		
		0100-1111	—	Reserved	—	—		
	IMCR[66]	0010	ETC1	eTimer_1	eTimer_1 Input Data Channel 1	I		
	IMCR[92]	0010	B1	FlexPWM_0	FlexPWM_0 Channel B Input 1	I		
D[1]	MSCR[49]	0000 (Default)	GPIO[49]	SIUL2-GPIO[49]	General Purpose IO D[1]	I/O	3	E3
		0001	—	Reserved	—	—		
		0010	ETC2	eTimer_1	eTimer_1 Input/Output Data Channel 2	I/O		
		0011	EXT_TGR	CTU_0	CTU 0 External Trigger Output	O		
		0100-1111	—	Reserved	—	—		
	IMCR[67]	0011	ETC2	eTimer_1	eTimer_1 Input Data Channel 2	I		
	IMCR[136]	0001	FR_A_RX	FLEXRAY	FlexRay Channel A Receive Pin	I		
D[2]	MSCR[50]	0000 (Default)	GPIO[50]	SIUL2-GPIO[50]	General Purpose IO D[2]	I/O	140	B4
		0001	—	Reserved	—	—		
		0010	ETC3	eTimer_1	eTimer_1 Input/Output Data Channel 3	I/O		
		0011	X3	FlexPWM_0	FlexPWM_0 Auxiliary Input/Output 3	I/O		

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